

+5V Powered RS-232 Transmitters/Receivers

The HIN230-HIN241 family of RS-232 transmitters/receivers interface circuits meet all EIA RS-232E and V.28 specifications, and are particularly suited for those applications where $\pm 12\text{V}$ is not available. They require a single +5V power supply (except HIN231 and HIN239) and feature onboard charge pump voltage converters which generate +10V and -10V supplies from the 5V supply. The HIN233 and HIN235 require no external capacitors and are ideally suited for applications where circuit board space is critical. The family of devices offer a wide variety of RS-232 transmitter/receiver combinations to accommodate various applications (see Selection Table).

The drivers feature true TTL/CMOS input compatibility, slew-rate-limited output, and 300 Ω power-off source impedance. The receivers can handle up to $\pm 30\text{V}$, and have a 3k Ω to 7k Ω input impedance. The receivers also feature hysteresis to greatly improve noise rejection.

Features

- Meets All RS-232E and V.28 Specifications
- Requires Only Single +5V Power Supply
 - (+5V and +12V - HIN231 and HIN239)
- High Data Rate 120kbps
- HIN233 and HIN235 Require No External Capacitors
- Onboard Voltage Doubler/Inverter
- Low Power Consumption
- Low Power Shutdown Function
- Three-State TTL/CMOS Receiver Outputs
- Multiple Drivers
 - $\pm 10\text{V}$ Output Swing for 5V Input
 - 300 Ω Power-Off Source Impedance
 - Output Current Limiting
 - TTL/CMOS Compatible
 - 30V/ μs Maximum Slew Rate
- Multiple Receivers
 - $\pm 30\text{V}$ Input Voltage Range
 - 3k Ω to 7k Ω Input Impedance
 - 0.5V Hysteresis to Improve Noise Rejection

Applications

- Any System Requiring RS-232 Communication Ports
 - Computer - Portable, Mainframe, Laptop
 - Peripheral - Printers and Terminals
 - Instrumentation
 - Modems

Selection Table

PART NUMBER	POWER SUPPLY VOLTAGE	NUMBER OF RS-232 DRIVERS	NUMBER OF RS-232 RECEIVERS	EXTERNAL COMPONENTS	LOW POWER SHUTDOWN/TTL THREE-STATE	NUMBER OF LEADS
HIN230	+5V	5	0	4 Capacitors	Yes/No	20
HIN231	+5V and +7.5V to 13.2V	2	2	2 Capacitors	No/No	16
HIN232	+5V	2	2	4 Capacitors	No/No	16
HIN233	+5V	2	2	None	No/No	20
HIN234	+5V	4	0	4 Capacitors	No/No	16
HIN235	+5V	5	5	None	Yes/Yes	24
HIN236	+5V	4	3	4 Capacitors	Yes/Yes	24
HIN237	+5V	5	3	4 Capacitors	No/No	24
HIN238	+5V	4	4	4 Capacitors	No/No	24
HIN239	+5V and +7.5V to 13.2V	3	5	2 Capacitors	No/Yes	24
HIN240	+5V	5	5	4 Capacitors	Yes/Yes	44
HIN241	+5V	4	5	4 Capacitors	Yes/Yes	28

Ordering Information

PART NUMBER	TEMP. RANGE (°C)	PACKAGE	PKG. NO.
HIN230CB	0 to 70	20 Ld SOIC	M20.3
HIN230IB	-40 to 85	20 Ld SOIC	M20.3
HIN231CB	0 to 70	16 Ld SOIC	M16.3
HIN231CP	0 to 70	14 Ld PDIP	E14.3
HIN231IB	-40 to 85	16 Ld SOIC	M16.3
HIN231IP	-40 to 85	14 Ld PDIP	E14.3
HIN232CP	0 to 70	16 Ld PDIP	E16.3
HIN232CB	0 to 70	16 Ld SOIC	M16.3
HIN232IP	-40 to 85	16 Ld PDIP	E16.3
HIN232IB	-40 to 85	16 Ld SOIC	M16.3
HIN233CP	0 to 70	20 Ld PDIP	E20.3
HIN234CB	0 to 70	16 Ld SOIC	M16.3
HIN234IB	-40 to 85	16 Ld SOIC	M16.3
HIN235CP	0 to 70	24 Ld PDIP	E24.6
HIN236CP	0 to 70	24 Ld PDIP	E24.3
HIN236CB	0 to 70	24 Ld SOIC	M24.3
HIN236IP	-40 to 85	24 Ld PDIP	E24.3
HIN236IB	-40 to 85	24 Ld SOIC	M24.3

PART NUMBER	TEMP. RANGE (°C)	PACKAGE	PKG. NO.
HIN237CP	0 to 70	24 Ld PDIP	E24.3
HIN237CB	0 to 70	24 Ld SOIC	M24.3
HIN237IP	-40 to 85	24 Ld PDIP	E24.3
HIN237IB	-40 to 85	24 Ld SOIC	M24.3
HIN238CP	0 to 70	24 Ld PDIP	E24.3
HIN238CB	0 to 70	24 Ld SOIC	M24.3
HIN238IP	-40 to 85	24 Ld PDIP	E24.3
HIN238IB	-40 to 85	24 Ld SOIC	M24.3
HIN239CB	0 to 70	24 Ld SOIC	M24.3
HIN239CP	0 to 70	24 Ld PDIP	E24.3
HIN239IB	-40 to 85	24 Ld SOIC	M24.3
HIN240CN	0 to 70	44 Ld MQFP	Q44.10X10
HIN240IN	-40 to 85	44 Ld MQFP	Q44.10X10
HIN241CB	0 to 70	28 Ld SOIC	M28.3
HIN241IB	-40 to 85	28 Ld SOIC	M28.3
HIN241CA	0 to 70	28 Ld SSOP	M28.209
HIN241IA	-40 to 85	28 Ld SSOP	M28.209

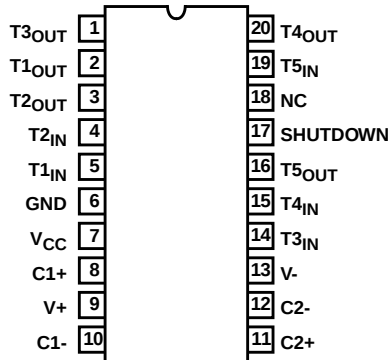
NOTE: Many of the surface mount devices are available on tape and reel; add -T to suffix.

Pin Descriptions

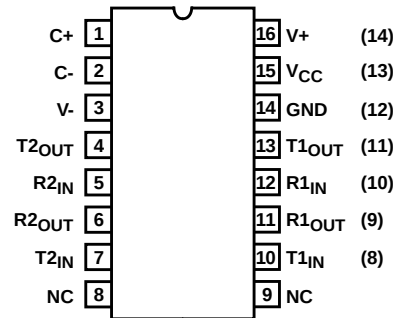
PIN	FUNCTION
V _{CC}	Power Supply Input 5V ±10%.
V+	Internally generated positive supply (+10V nominal), HIN231 and HIN239 require +7.5V to +13.2V.
V-	Internally generated negative supply (-10V nominal).
GND	Ground lead. Connect to 0V.
C1+	External capacitor (+ terminal) is connected to this lead.
C1-	External capacitor (- terminal) is connected to this lead.
C2+	External capacitor (+ terminal) is connected to this lead.
C2-	External capacitor (- terminal) is connected to this lead.
T _{IN}	Transmitter Inputs. These leads accept TTL/CMOS levels. An internal 400kΩ pull-up resistor to V _{CC} is connected to each lead.
T _{OUT}	Transmitter Outputs. These are RS-232 levels (nominally ±10V).
R _{IN}	Receiver Inputs. These inputs accept RS-232 input levels. An internal 5kΩ pull-down resistor to GND is connected to each input.
R _{OUT}	Receiver Outputs. These are TTL/CMOS levels.
EN	Enable input. This is an active low input which enables the receiver outputs. With EN = 5V, the outputs are placed in a high impedance state.
SHUTDOWN	Shutdown Input. With SHUTDOWN = 5V, the charge pump is disabled, the receiver outputs are in a high impedance state and the transmitters are shut off.
NC	No Connect. No connections are made to these leads.

Pinouts

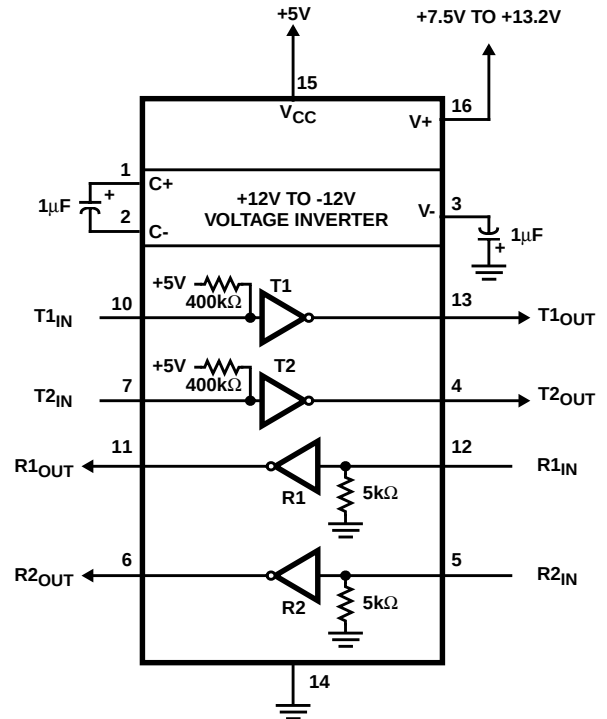
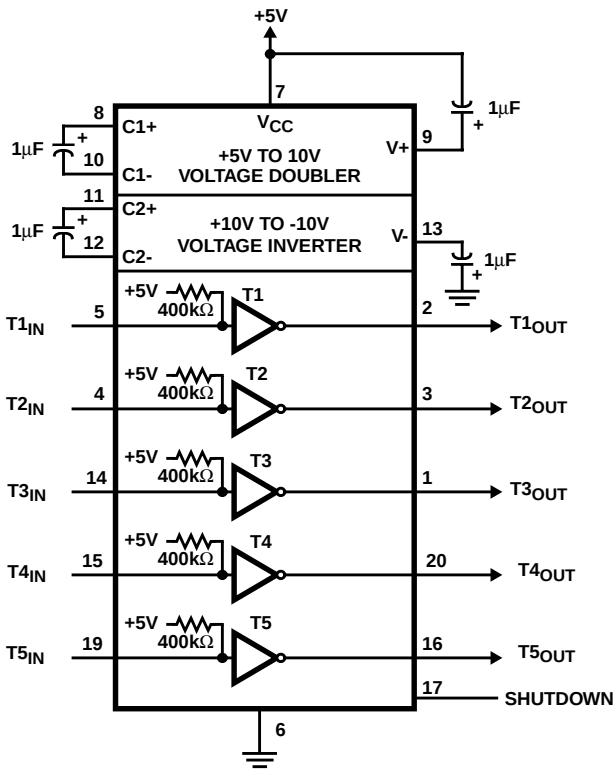
HIN230 (SOIC)
TOP VIEW



HIN231 (SOIC)
TOP VIEW



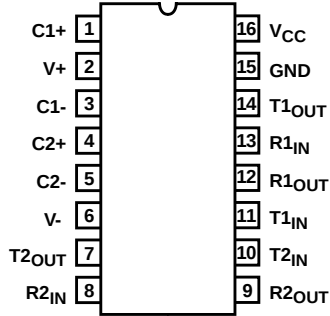
NOTE: Pin numbers in parentheses are for PDIP Package.



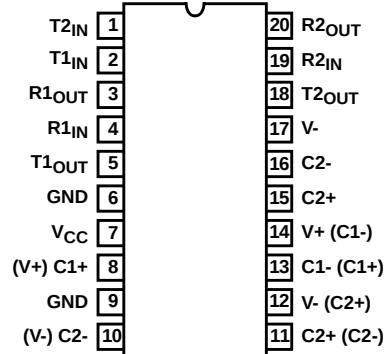
NOTE: SOIC pin numbers shown.

Pinouts (Continued)

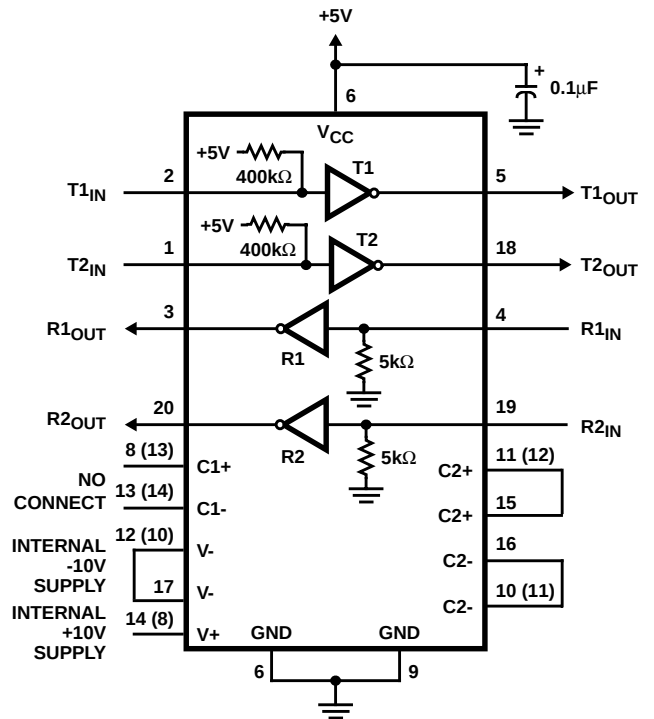
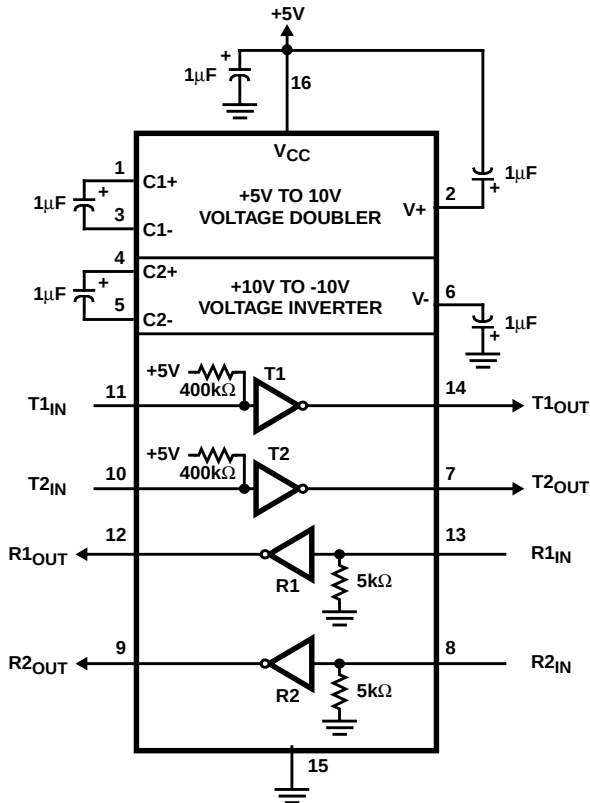
HIN232 (PDIP, SOIC)
TOP VIEW



HIN233 (PDIP, SOIC)
TOP VIEW



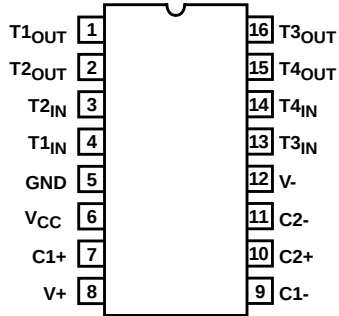
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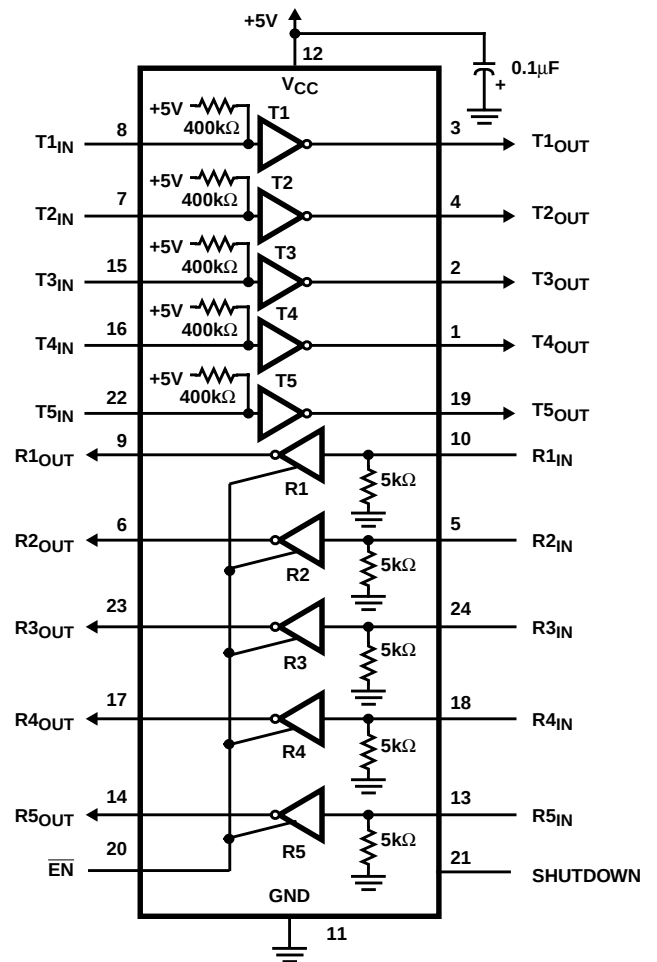
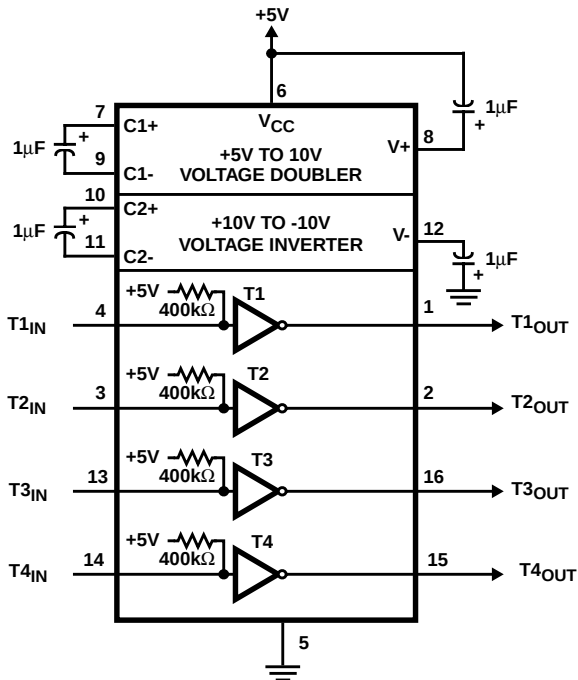
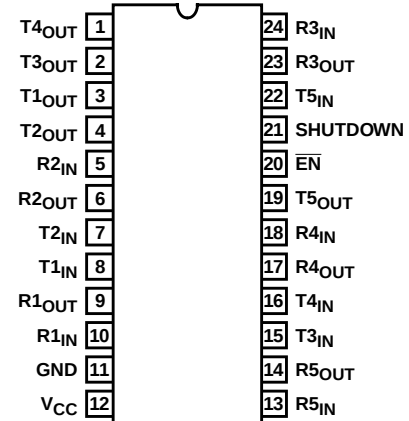
NOTE: Pin numbers in parentheses are for SOIC Package.

Pinouts (Continued)

HIN234 (SOIC)
TOP VIEW

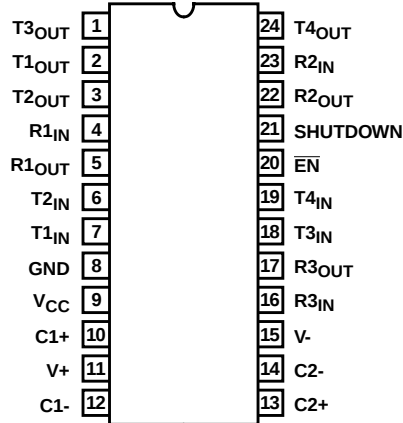


HIN235 (PDIP)
TOP VIEW

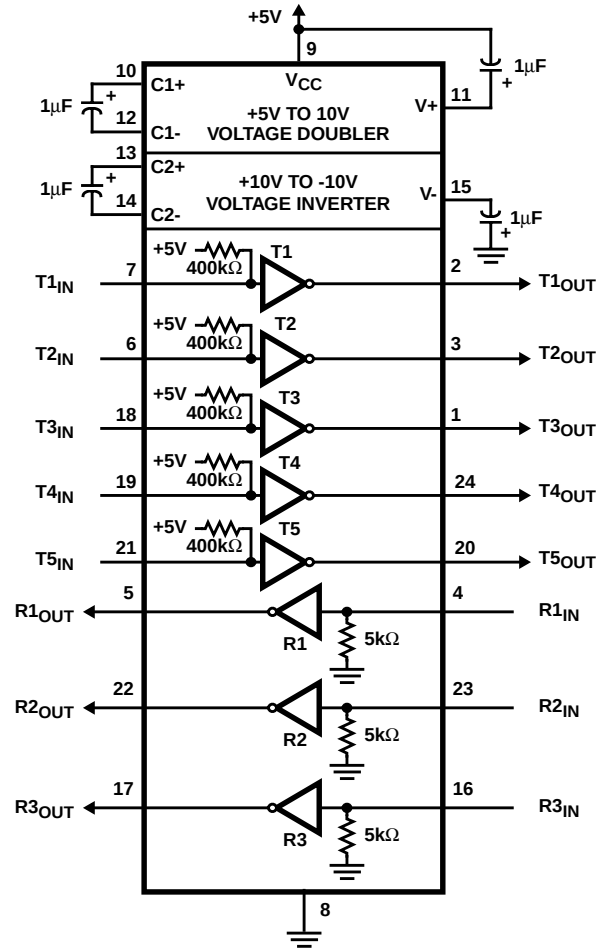
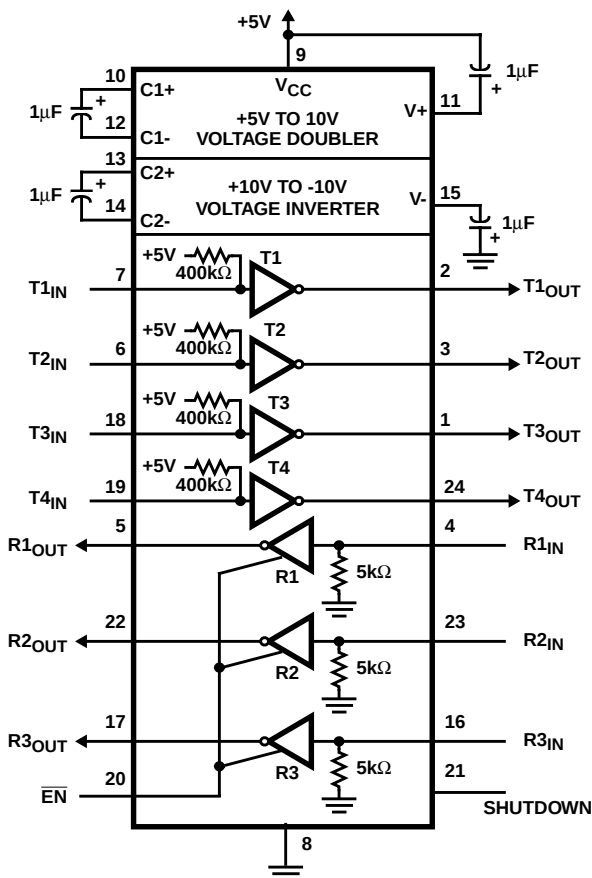
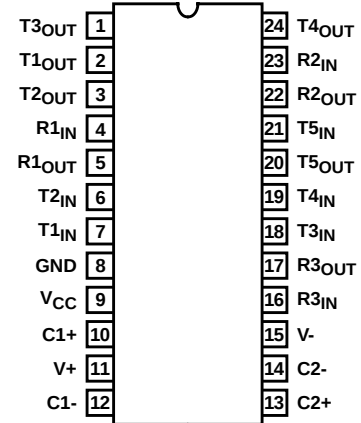


Pinouts (Continued)

HIN236 (PDIP, SOIC)
TOP VIEW

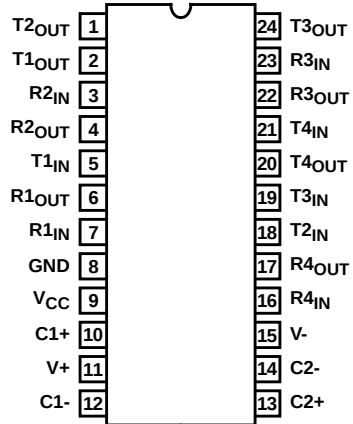


HIN237 (PDIP, SOIC)
TOP VIEW

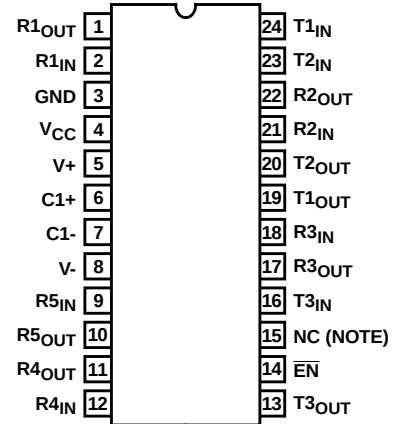


Pinouts (Continued)

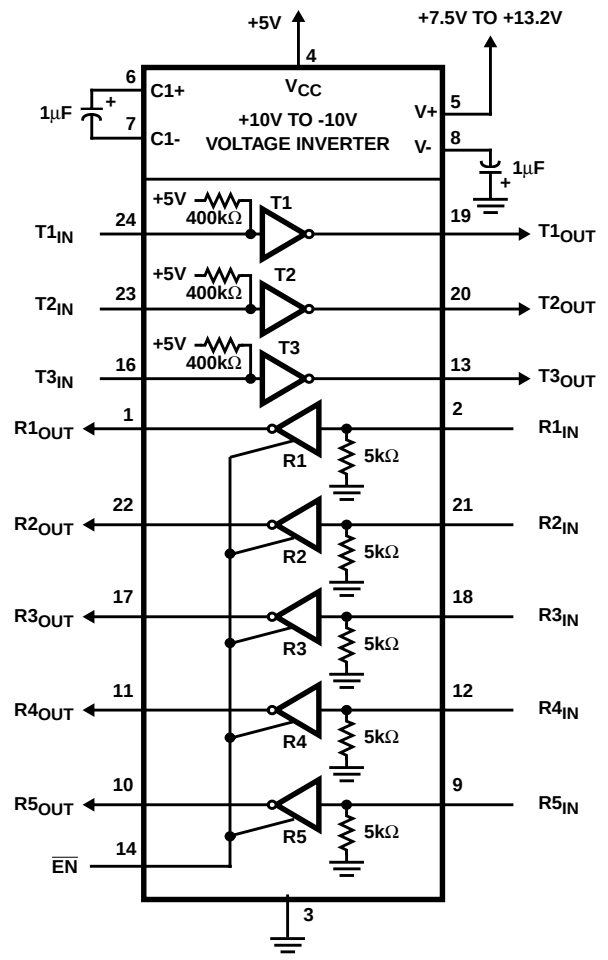
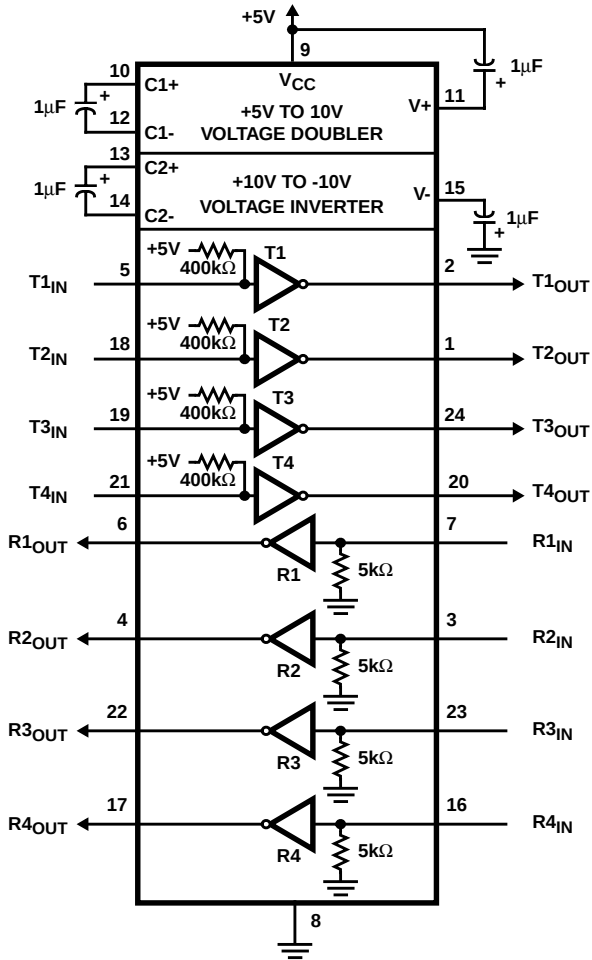
HIN238 (PDIP, SOIC)
TOP VIEW



HIN239 (SOIC)
TOP VIEW

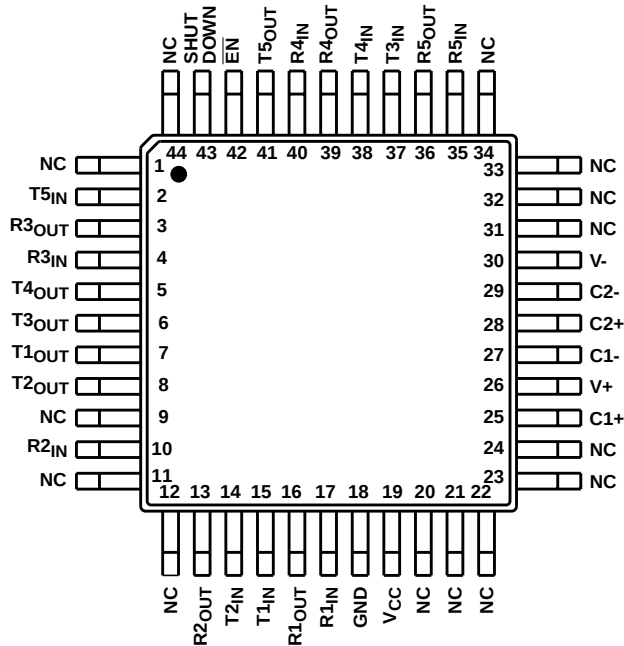
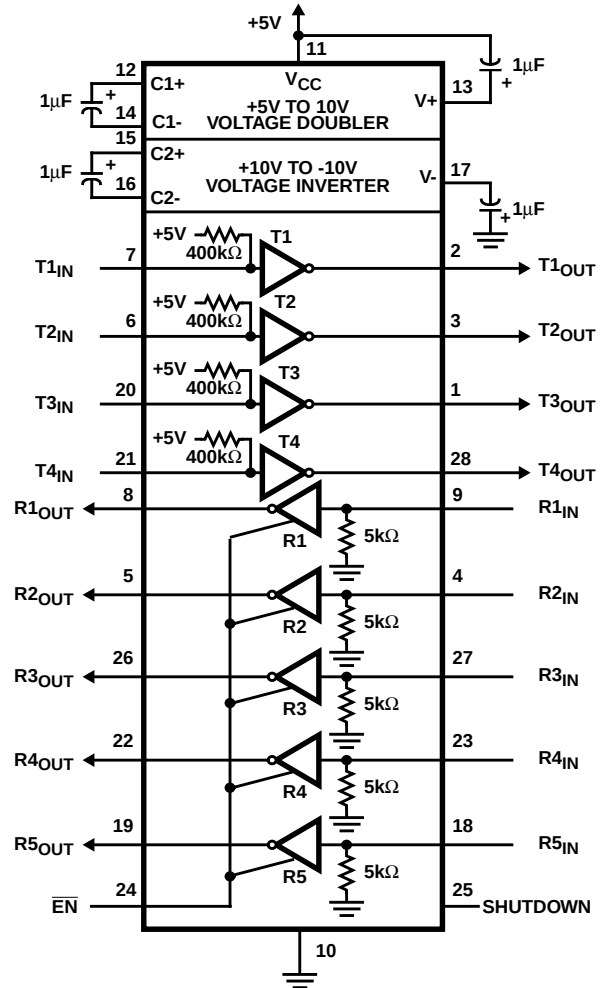
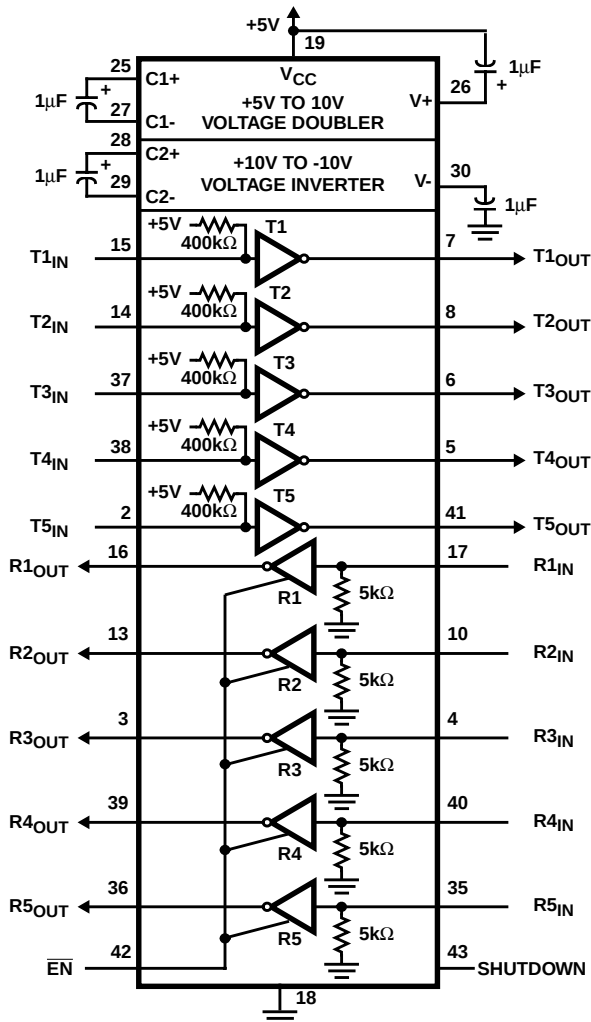
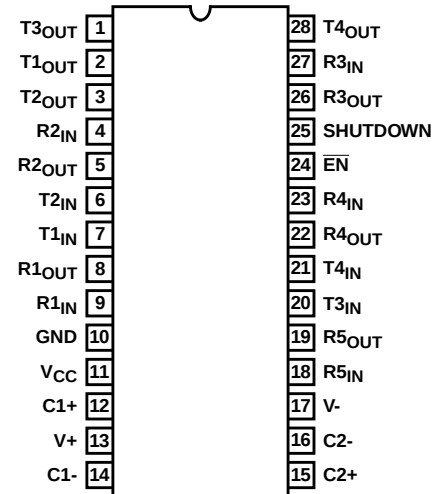


NOTE: No Connect



Pinouts (Continued)

HIN240 (MQFP)


HIN241 (SOIC, SSOP)
TOP VIEW


Absolute Maximum Ratings

V _{CC} to Ground	(GND -0.3V) < V _{CC} < 6V
V+ to Ground	(V _{CC} -0.3V) < V+ < 12V
V- to Ground	-12V < V- < (GND +0.3V)
Input Voltages	
T _{IN}	(V- -0.3V) < V _{IN} < (V+ +0.3V)
R _{IN}	±30V
Output Voltages	
T _{OUT}	(V- -0.3V) < V _{TXOUT} < (V+ +0.3V)
R _{OUT}	(GND -0.3V) < V _{RXOUT} < (V+ +0.3V)
Short Circuit Duration	
T _{OUT}	Continuous
R _{OUT}	Continuous

Operating Conditions

Temperature Range	
HIN2XXCX	0°C to 70°C
HIN2XXIX	-40°C to 85°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

1. θ_{JA} is measured with the component mounted on an evaluation PC board in free air.

Thermal Information

Thermal Resistance (Typical, Note 1)	θ_{JA} (°C/W)
14 Ld PDIP Package	90
16 Ld PDIP Package	90
20 Ld PDIP Package	80
24 Ld PDIP Package	70
16 Ld SOIC (W) Package	100
20 Ld SOIC Package	120
24 Ld SOIC Package	75
28 Ld SOIC Package	70
28 Ld SSOP Package	95
44 Ld MQFP Package	80
Maximum Junction Temperature (Plastic Package)	150°C
Maximum Storage Temperature Range	-65°C to 150°C
Maximum Lead Temperature (Soldering 10s)	300°C
(SOIC, SSOP, MQFP - Lead Tips Only)	

Electrical Specifications

Test Conditions: V_{CC} = +5V ±10%, T_A = Operating Temperature Range

PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNITS
SUPPLY CURRENTS						
Power Supply Current, I _{CC}	No Load, T _A = 25°C	HIN232-233	-	5	10	mA
		HIN230, HIN234-238, HIN240-241	-	7	15	mA
		HIN231, HIN239	-	0.4	1	mA
V+ Power Supply Current, I _{CC} No Load, T _A = 25°C	No Load, T _A = 25°C	HIN231	-	1.8	5	mA
		HIN239	-	5.0	15	mA
Shutdown Supply Current, I _{CC} (SD)	T _A = 25°C		-	1	10	μA
LOGIC AND TRANSMITTER INPUTS, RECEIVER OUTPUTS						
Input Logic Low, V _{IL}		T _{IN} , $\overline{\text{EN}}$, Shutdown	-	-	0.8	V
Input Logic High, V _{IH}		T _{IN}	2.0	-	-	V
		$\overline{\text{EN}}$, Shutdown	2.4	-	-	V
Transmitter Input Pullup Current, I _P		T _{IN} = 0V	-	15	200	μA
TTL/CMOS Receiver Output Voltage Low, V _{OL}		I _{OUT} = 1.6mA (HIN231-HIN233 I _{OUT} = 3.2mA)	-	0.1	0.4	V
TTL/CMOS Receiver Output Voltage High, V _{OH}		I _{OUT} = -1.0mA	3.5	4.6	-	V
RECEIVER INPUTS						
RS-232 Input Voltage Range V _{IN}			-30	-	+30	V
Receiver Input Impedance R _{IN}		V _{IN} = ±3V	3.0	5.0	7.0	kΩ
Receiver Input Low Threshold, V _{IN} (H-L)		V _{CC} = 5V, T _A = 25°C	0.8	1.2	-	V
Receiver Input High Threshold, V _{IN} (L-H)		V _{CC} = 5V, T _A = 25°C	-	1.7	2.4	V
Receiver Input Hysteresis V _{HYST}			0.2	0.5	1.0	V
TIMING CHARACTERISTICS						
Baud Rate (1 Transmitter Switching)		R _L = 3kΩ	120	-	-	kbps
Output Enable Time, t _{EN}		HIN235, 236, 239, 240, 241	-	400	-	ns
Output Disable Time, t _{DIS}		HIN235, 236, 239, 240, 241	-	250	-	ns

HIN230 thru HIN241

Electrical Specifications Test Conditions: $V_{CC} = +5V \pm 10\%$, $T_A =$ Operating Temperature Range (Continued)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Propagation Delay, t_{PD}	RS-232 to TTL	-	0.5	-	μs
Instantaneous Slew Rate SR	$C_L = 10pF$, $R_L = 3k\Omega$, $T_A = 25^\circ C$ (Note 2)	-	-	30	$V/\mu s$
Transition Region Slew Rate, SR_T	$R_L = 3k\Omega$, $C_L = 2500pF$ Measured from +3V to -3V or -3V to +3V, 1 Transmitter Switching	-	3	-	$V/\mu s$
TRANSMITTER OUTPUTS					
Output Voltage Swing, T_{OUT}	Transmitter Outputs, $3k\Omega$ to Ground	± 5	± 9	± 10	V
Output Resistance, R_{OUT}	$V_{CC} = V+ = V- = 0V$, $V_{OUT} = \pm 2V$	300	-	-	Ω
RS-232 Output Short Circuit Current, I_{SC}	T_{OUT} shorted to GND	-	± 10	-	mA

NOTE:

2. Guaranteed by design.

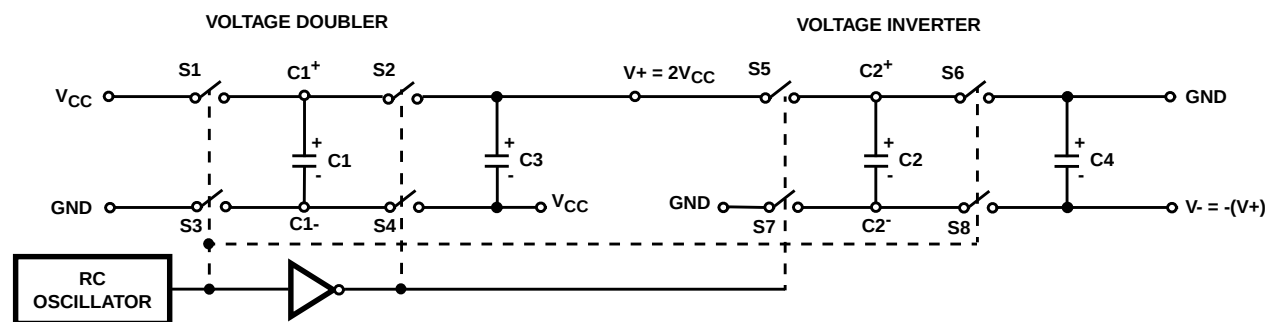


FIGURE 1. CHARGE PUMP

Detailed Description

The HIN230 thru HIN241 family of RS-232 transmitters/receivers are powered by a single +5V power supply (except HIN231 and HIN239), feature low power consumption, and meet all EIA RS-232C and V.28 specifications. The circuit is divided into three sections: The charge pump, transmitter, and receiver.

Charge Pump

An equivalent circuit of the charge pump is illustrated in Figure 1. The charge pump contains two sections: the voltage doubler and the voltage inverter. Each section is driven by a two phase, internally generated clock to generate +10V and -10V. The nominal clock frequency is 16kHz. During phase one of the clock, capacitor C1 is charged to V_{CC} . During phase two, the voltage on C1 is added to V_{CC} , producing a signal across C3 equal to twice V_{CC} . During phase one, C2 is also charged to $2V_{CC}$, and then during phase two, it is inverted with respect to ground to produce a signal across C4 equal to $-2V_{CC}$. The charge pump accepts input voltages up to 5.5V. The output impedance of the voltage doubler section ($V+$) is approximately 200Ω , and the output impedance of the voltage inverter section ($V-$) is approximately 450Ω . A typical application uses $1\mu\text{F}$ capacitors for C1-C4, however, the value is not critical. Increasing the values of C1 and C2 will lower the output impedance of the voltage doubler and inverter, increasing the values of the reservoir capacitors, C3 and C4, lowers the ripple on the $V+$ and $V-$ supplies.

During shutdown mode (HIN230, 235, 236, 240 and 241), SHUTDOWN control line set to logic "1", the charge pump is turned off, $V+$ is pulled down to V_{CC} , $V-$ is pulled up to GND, and the supply current is reduced to less than $10\mu\text{A}$. The transmitter outputs are disabled and the receiver outputs are placed in the high impedance state.

Transmitters

The transmitters are TTL/CMOS compatible inverters which translate the inputs to RS-232 outputs. The input logic threshold is about 26% of V_{CC} , or 1.3V for $V_{CC} = 5\text{V}$. A logic 1 at the input results in a voltage of between -5V and $V-$ at the output, and a logic 0 results in a voltage between +5V and ($V+ - 0.6\text{V}$). Each transmitter input has an internal $400\text{k}\Omega$ pullup

resistor so any unused input can be left unconnected and its output remains in its low state. The output voltage swing meets the RS-232C specifications of $\pm 5\text{V}$ minimum with the worst case conditions of: all transmitters driving $3\text{k}\Omega$ minimum load impedance, $V_{CC} = 4.5\text{V}$, and maximum allowable operating temperature. The transmitters have an internally limited output slew rate which is less than $30\text{V}/\mu\text{s}$. The outputs are short circuit protected and can be shorted to ground indefinitely. The powered down output impedance is a minimum of 300Ω with $\pm 2\text{V}$ applied to the outputs and $V_{CC} = 0\text{V}$.

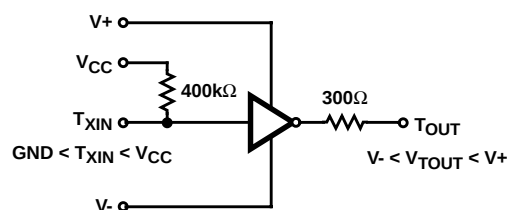


FIGURE 2. TRANSMITTER

Receivers

The receiver inputs accept up to $\pm 30\text{V}$ while presenting the required $3\text{k}\Omega$ to $7\text{k}\Omega$ input impedance even if the power is off ($V_{CC} = 0\text{V}$). The receivers have a typical input threshold of 1.3V which is within the $\pm 3\text{V}$ limits, known as the transition region, of the RS-232 specifications. The receiver output is 0V to V_{CC} . The output will be low whenever the input is greater than 2.4V and high whenever the input is floating or driven between +0.8V and -30V. The receivers feature 0.5V hysteresis to improve noise rejection. The receiver Enable line $\overline{\text{EN}}$, when set to logic "1", (HIN235, 236, 239, 240, and 241) disables the receiver outputs, placing them in the high impedance mode. The receiver outputs are also placed in the high impedance state when in shutdown mode.

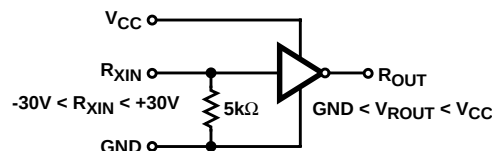


FIGURE 3. RECEIVER

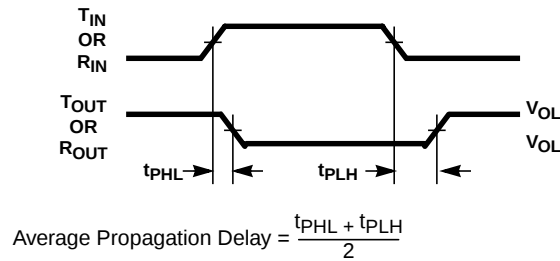
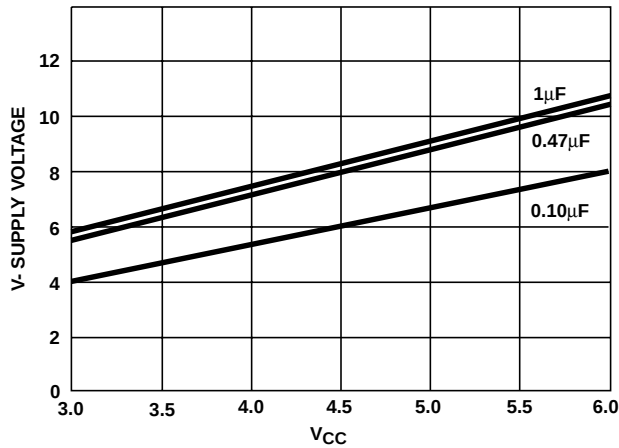
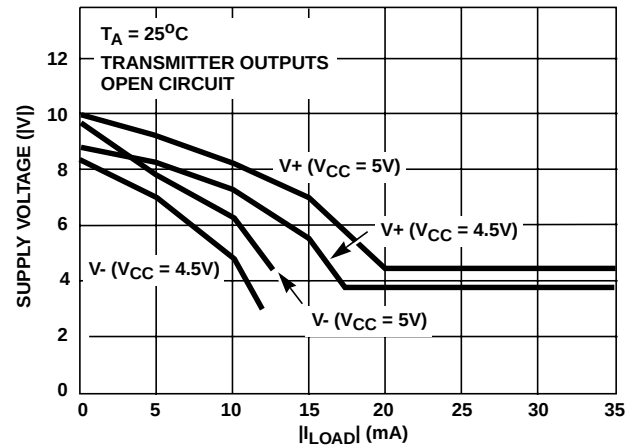


FIGURE 4. PROPAGATION DELAY DEFINITION

Typical Performance Curves


FIGURE 5. V- SUPPLY VOLTAGE vs V_{CC} , VARYING CAPACITORS

FIGURE 6. V_+ , V_- OUTPUT VOLTAGE vs LOAD (HIN232)

Test Circuits (HIN232)

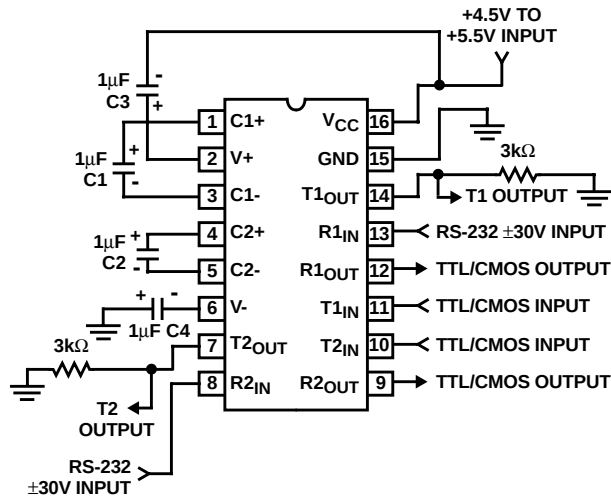


FIGURE 7. GENERAL TEST CIRCUIT

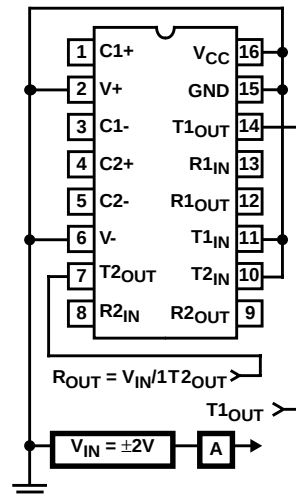


FIGURE 8. POWER-OFF SOURCE RESISTANCE CONFIGURATION

Applications

The HIN2XX may be used for all RS-232 data terminal and communication links. It is particularly useful in applications where $\pm 12\text{V}$ power supplies are not available for conventional RS-232 interface circuits. The applications presented represent typical interface configurations.

A simple duplex RS-232 port with CTS/RTS handshaking is illustrated in Figure 9. Fixed output signals such as DTR (data terminal ready) and DSRS (data signaling rate select) is generated by driving them through a $5\text{k}\Omega$ resistor connected to V^+ .

In applications requiring four RS-232 inputs and outputs (Figure 10), note that each circuit requires two charge pump capacitors ($C1$ and $C2$) but can share common reservoir capacitors ($C3$ and $C4$). The benefit of sharing common reservoir capacitors is the elimination of two capacitors and the reduction of the charge pump source impedance which effectively increases the output swing of the transmitters.

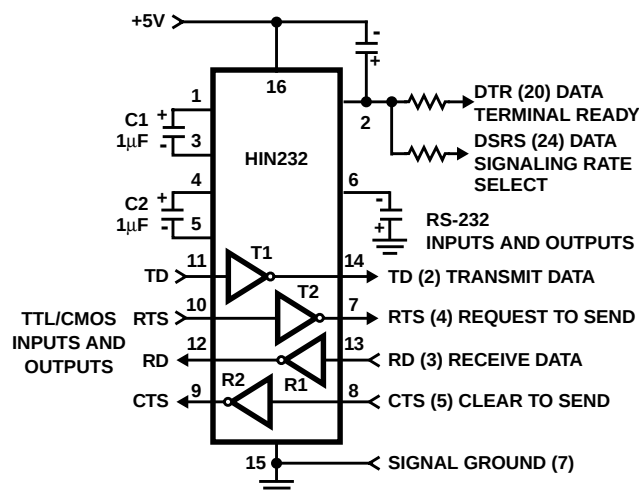


FIGURE 9. SIMPLE DUPLEX RS-232 PORT WITH CTS/RTS HANDSHAKING

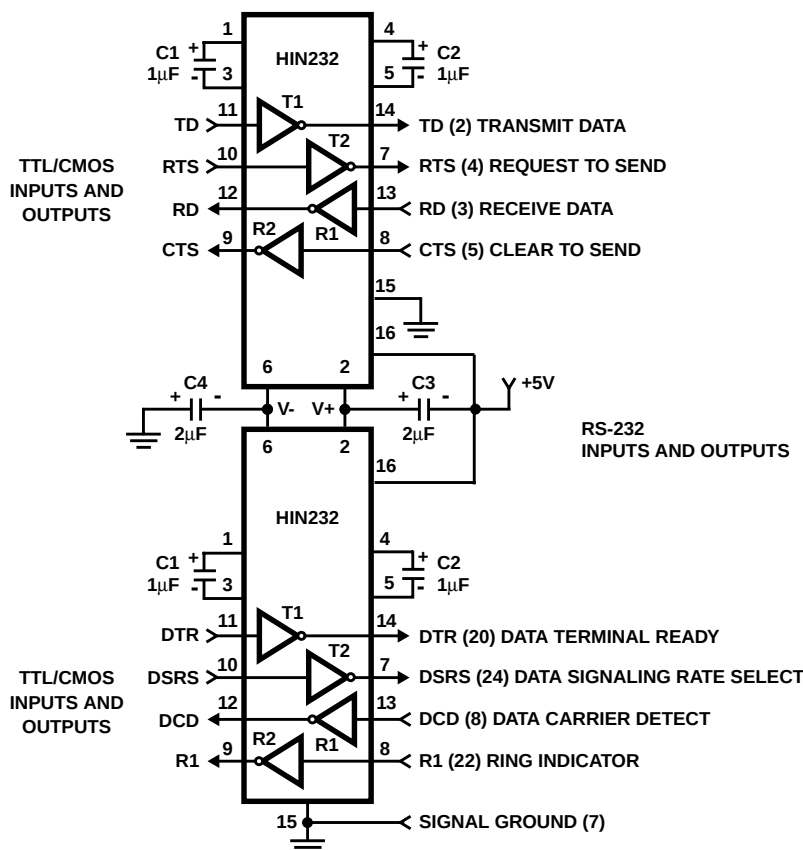


FIGURE 10. COMBINING TWO HIN232s FOR 4 PAIRS OF RS-232 INPUTS AND OUTPUTS

Die Characteristics

DIE DIMENSIONS:

160 mils x 140 mils

METALLIZATION:

Type: Al

Thickness: $10\text{k}\text{\AA} \pm 1\text{k}\text{\AA}$

SUBSTRATE POTENTIAL

V+

PASSIVATION:

Type: Nitride over Silox

Nitride Thickness: $8\text{k}\text{\AA}$

Silox Thickness: $7\text{k}\text{\AA}$

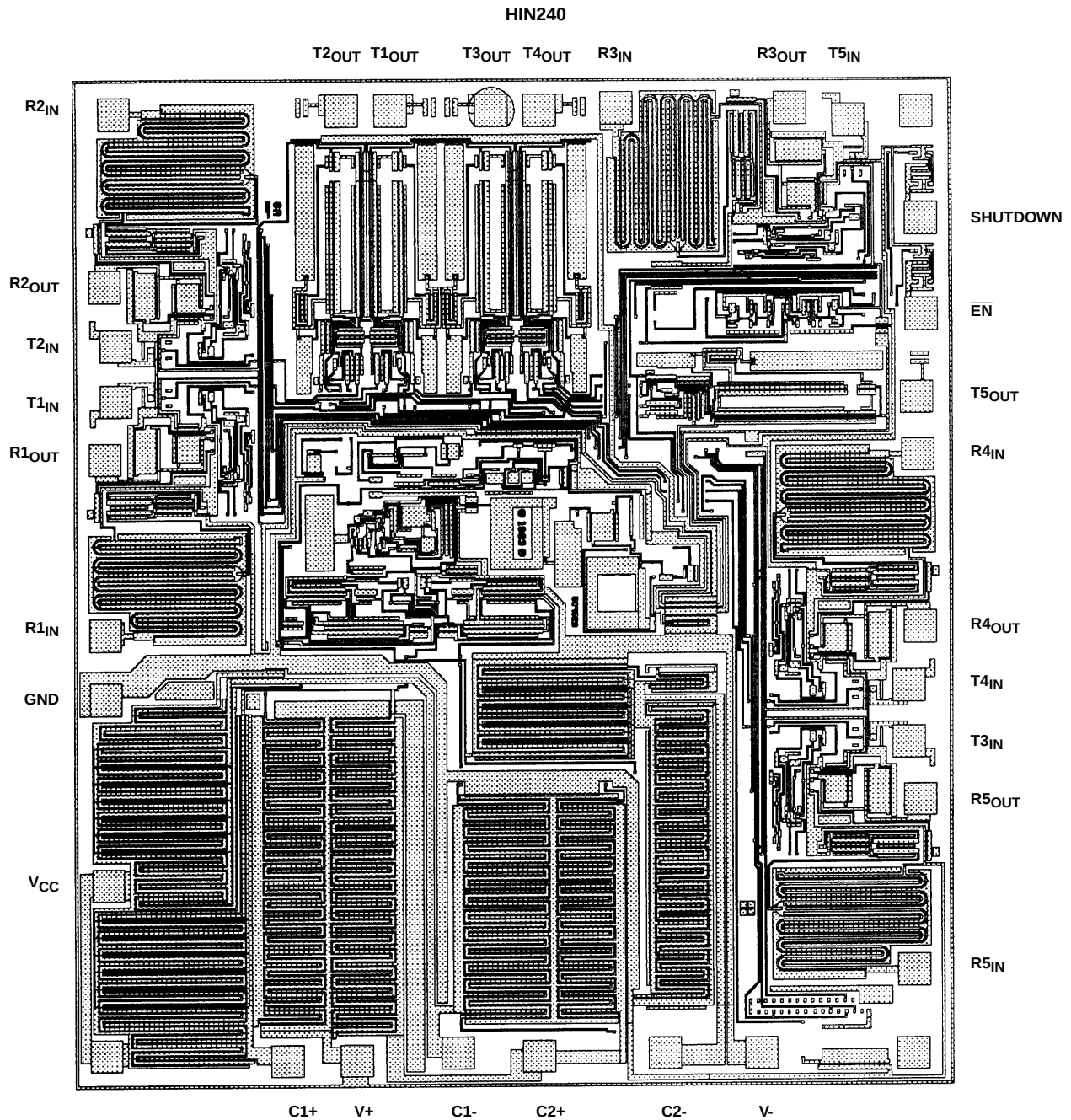
TRANSISTOR COUNT:

238

PROCESS:

CMOS Metal Gate

Metallization Mask Layout



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